



General Description

AFC3346W, N & P Pair enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

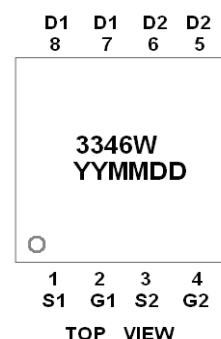
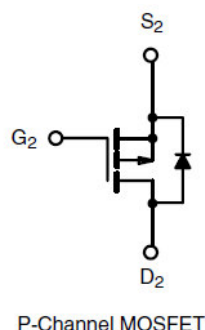
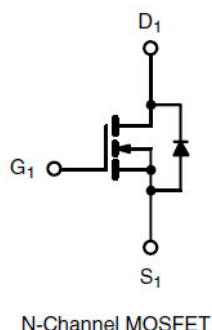
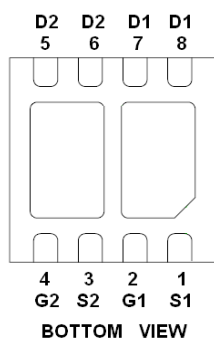
N-Channel

- 40V/15A, $R_{DS(ON)} = 28m\Omega @ V_{GS} = 10V$
- 40V/12A, $R_{DS(ON)} = 38m\Omega @ V_{GS} = 4.5V$

P-Channel

- -40V/-12A, $R_{DS(ON)} = 45m\Omega @ V_{GS} = -10V$
- -40V/-10A, $R_{DS(ON)} = 62m\Omega @ V_{GS} = -4.5V$

Pin Description (DFN3X3-8L)



Application

- DC/DC Conversion
- Load Switch
- DC FAN

Pin Define

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	S2	Source 2
4	G2	Gate 2
5	D2	Drain 2
6	D2	Drain 2
7	D1	Drain 1
8	D1	Drain 1

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFC3346WFN338RG	3346W YYMMDD	DFN3X3-8L	Tape & Reel	5000 EA

※ YY year code

※ MM month code

※ DD date code

※ AFC3346WFN338RG : 13" Tape & Reel ; Pb- Free ; Halogen- Free



Absolute Maximum Ratings (N-Channel)

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	40	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _D	T _A =25°C	15
		T _A =70°C	12
Pulsed Drain Current	I _{DM}	40	A
Continuous Source Current(Diode Conduction)	I _S	10	A
Power Dissipation	P _D	T _A =25°C	2
		T _A =70°C	1.5
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	56	°C/W

Electrical Characteristics (N-Channel)

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.0		3.0	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =32V, V _{GS} =0V			1	uA
		V _{DS} =32V, V _{GS} =0V T _J =85°C			10	
On-State Drain Current	I _{D(on)}	V _{DS} ≥ 5V, V _{GS} =10V	20			A
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =15A		20	28	mΩ
		V _{GS} =4.5V, I _D =12A		30	38	
Forward Transconductance	g _{FS}	V _{DS} =15V, I _D =5.0A		25		S
Diode Forward Voltage	V _{SD}	I _S =2A, V _{GS} =0V		0.85	1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =20V, V _{GS} =4.5V I _D = 5A		10	14	nC
Gate-Source Charge	Q _{gs}			2.8		
Gate-Drain Charge	Q _{gd}			3.2		
Input Capacitance	C _{iss}	V _{DS} =20V, V _{GS} =0V f=1MHz		850		pF
Output Capacitance	C _{oss}			110		
Reverse Transfer Capacitance	C _{rss}			75		
Turn-On Time	t _{d(on)}	V _{DD} =20V, R _L =4Ω I _D ≅5.0A, V _{GEN} =10V R _G =1Ω		6	12	ns
	t _r			10	20	
Turn-Off Time	t _{d(off)}			20	36	
	t _f			6	12	



Absolute Maximum Ratings (P-Channel)

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-40	V
Gate -Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _D	T _A =25°C	-12.0
		T _A =70°C	-10.0
Pulsed Drain Current	I _{DM}	-40	A
Continuous Source Current(Diode Conduction)	I _S	-10	A
Power Dissipation	P _D	T _A =25°C	1.8
		T _A =70°C	1.2
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	62.5	°C/W

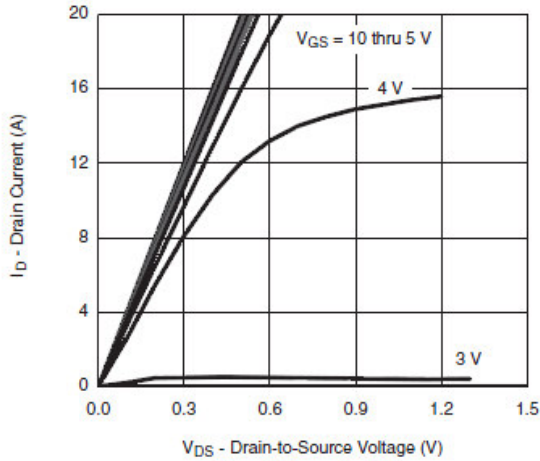
Electrical Characteristics (P-Channel)

(T_A=25°C Unless otherwise noted)

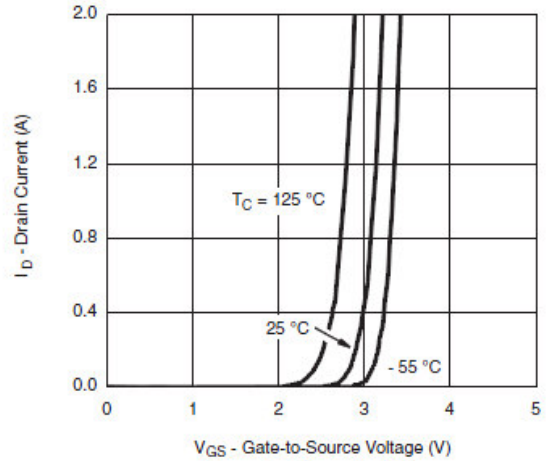
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D = -250uA	-40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D = -250uA	-1.0		-3.0	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -32V, V _{GS} =0V			-1	
		V _{DS} = -32V, V _{GS} =0V T _J =85°C			-20	uA
On-State Drain Current	I _{D(on)}	V _{DS} ≥ -5V, V _{GS} = -10V	-20			A
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = -10V, I _D =-12A		34	45	mΩ
		V _{GS} = -4.5V, I _D =-10A		48	62	
Forward Transconductance	g _{FS}	V _{DS} = -15V, I _D = -5A		20		S
Diode Forward Voltage	V _{SD}	I _S = -2A, V _{GS} =0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =-20V, V _{GS} =-4.5V I _D = -5.0A		13	20	nC
Gate-Source Charge	Q _{gs}			4.5		
Gate-Drain Charge	Q _{gd}			6.5		
Input Capacitance	C _{iss}	V _{DS} =-20V, V _{GS} =0V f=1MHz		1100		pF
Output Capacitance	C _{oss}			145		
Reverse Transfer Capacitance	C _{rss}			115		
Turn-On Time	t _{d(on)}	V _{DD} =-20V, R _L =4Ω I _D ≡-5.0A, V _{GEN} =-4.5V R _G =1Ω		40	80	ns
	t _r			55	100	
Turn-Off Time	t _{d(off)}			30	60	
	t _f			12	20	



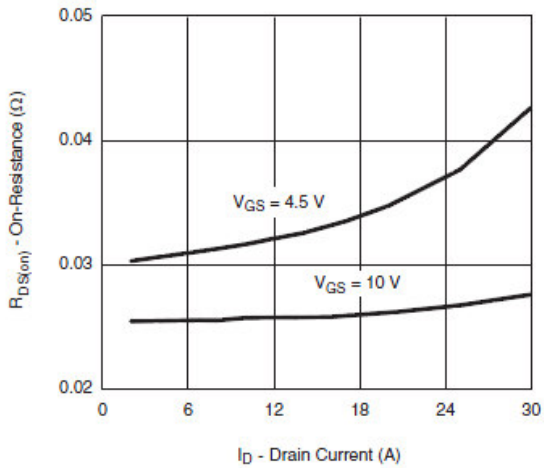
Typical Characteristics (N-Channel)



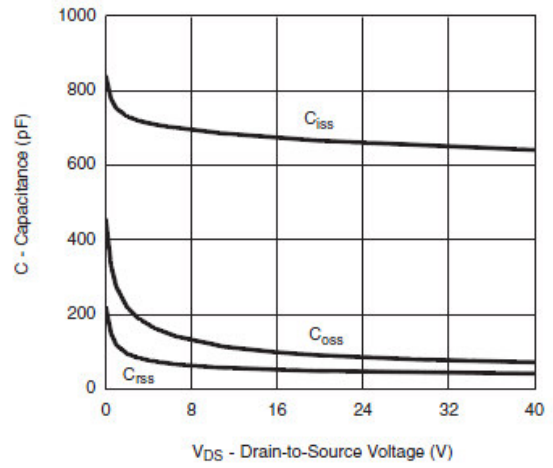
Output Characteristics



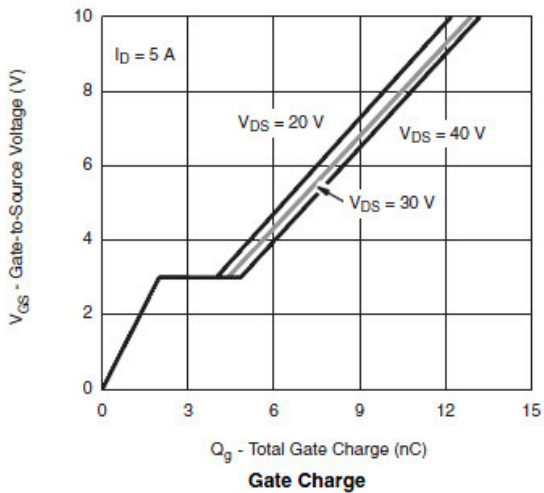
Transfer Characteristics



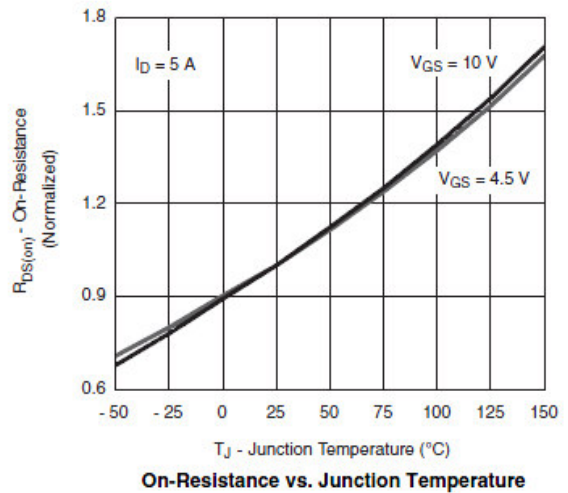
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



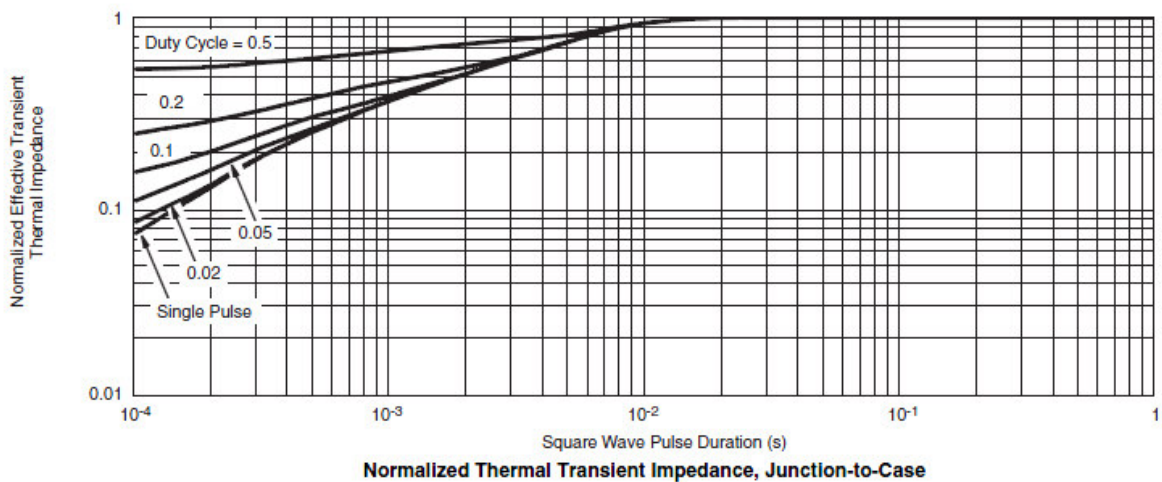
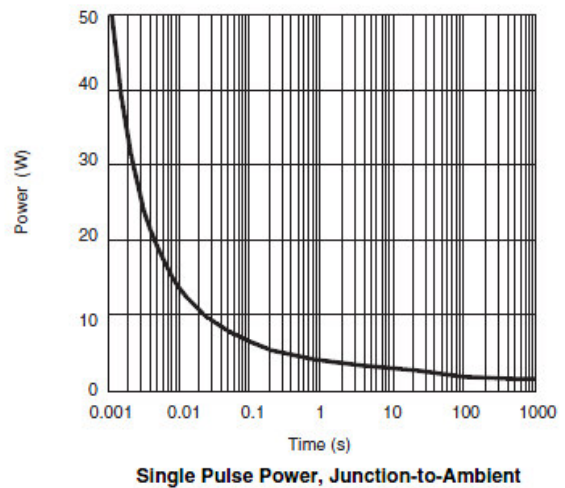
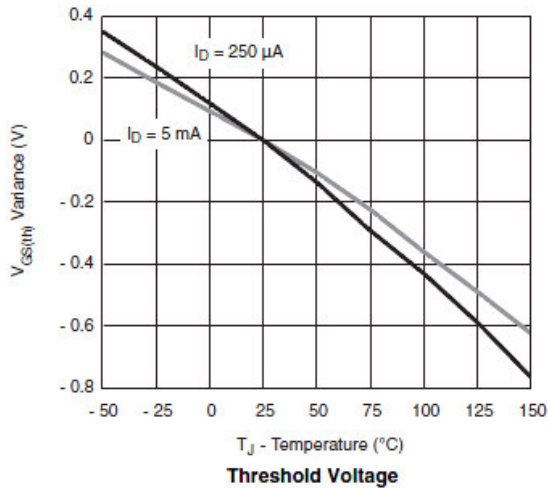
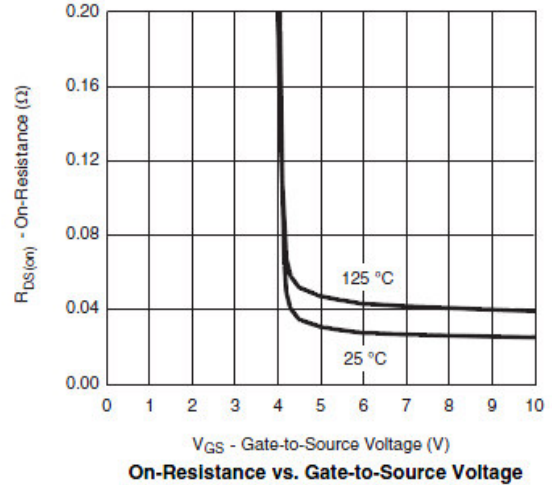
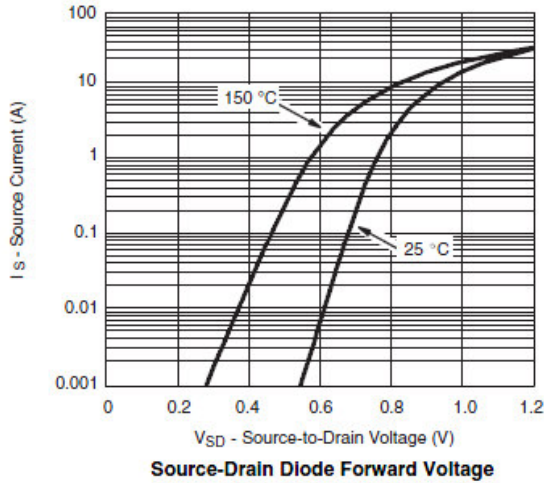
Gate Charge



On-Resistance vs. Junction Temperature

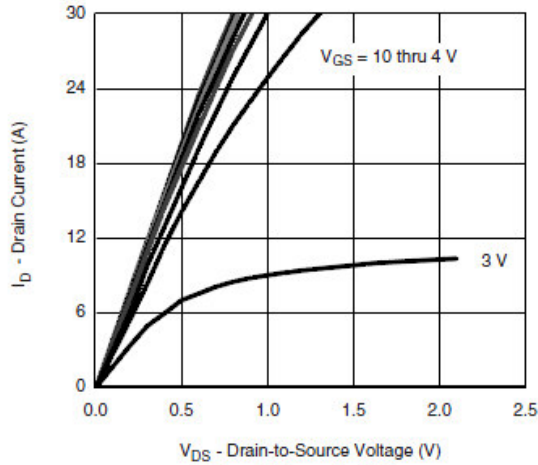


Typical Characteristics (N-Channel)

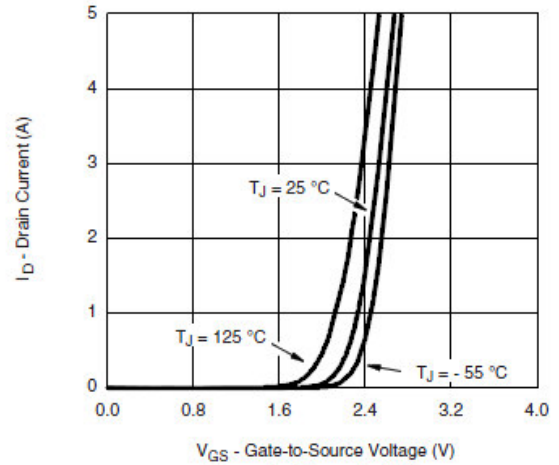




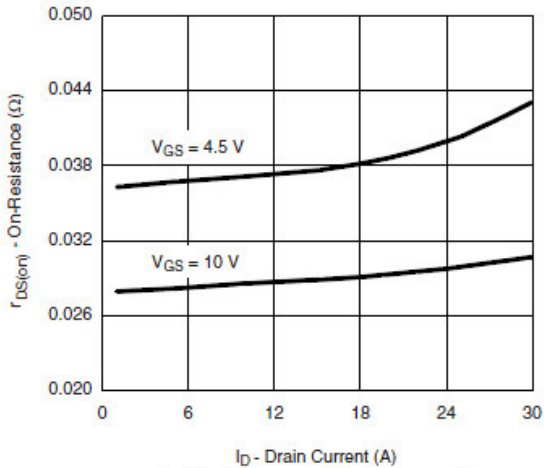
Typical Characteristics (P-Channel)



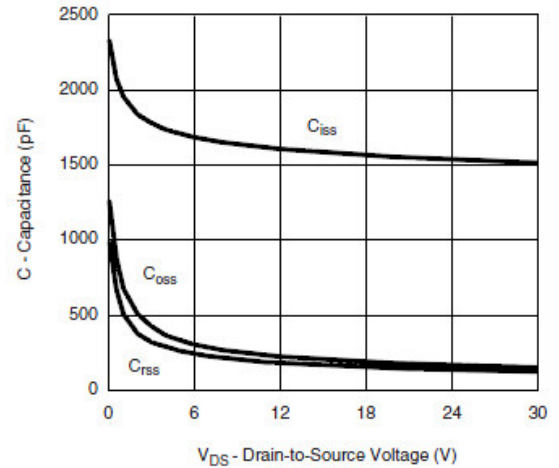
Output Characteristics



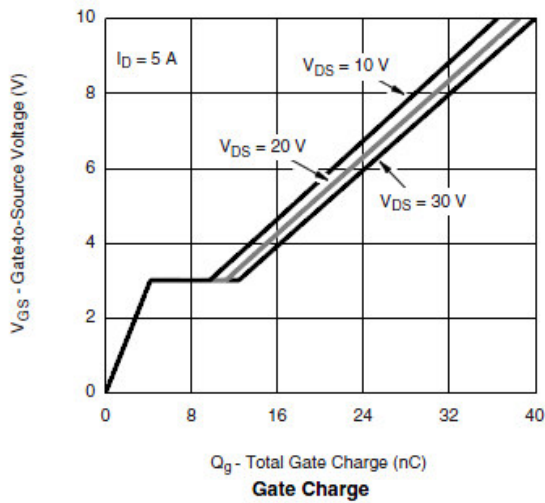
Transfer Characteristics



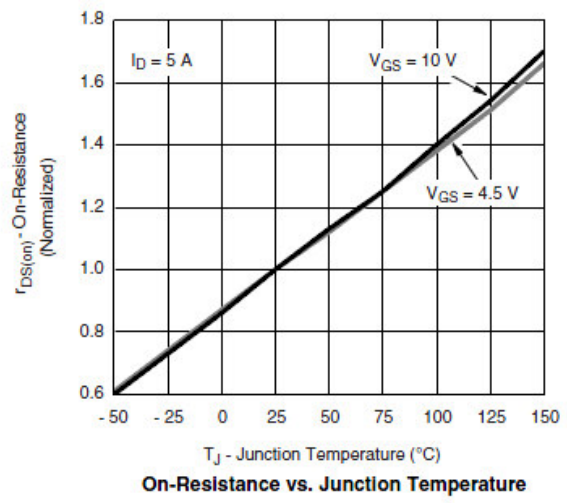
On-Resistance vs. Drain Current



Capacitance



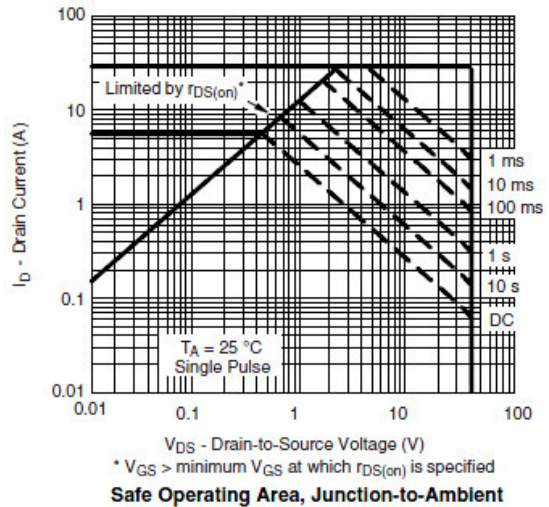
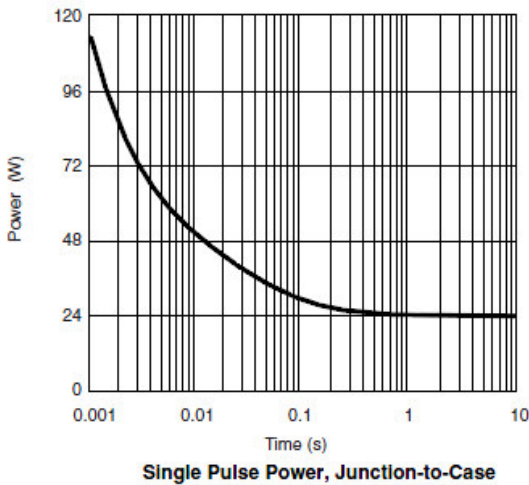
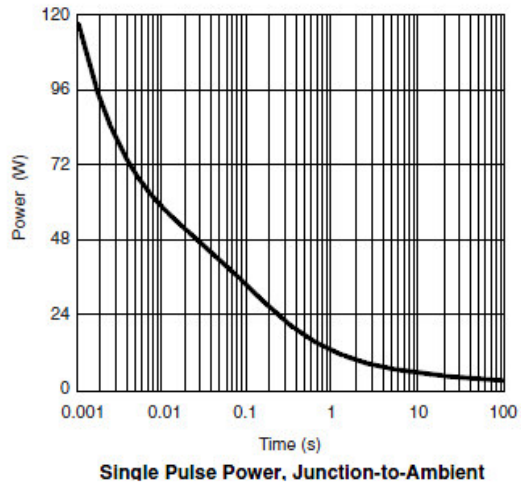
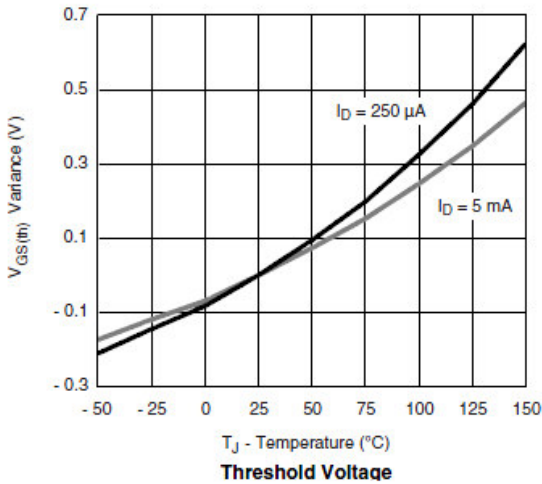
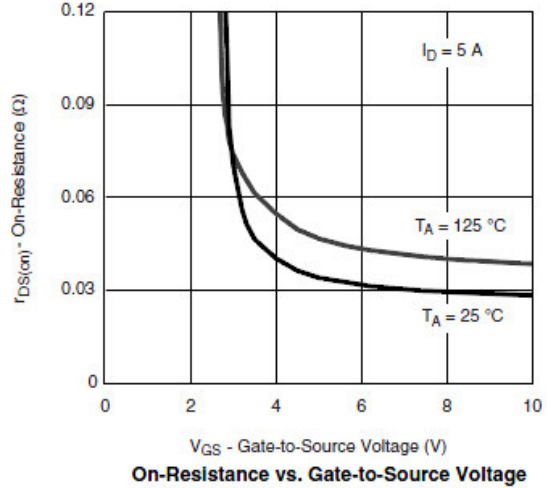
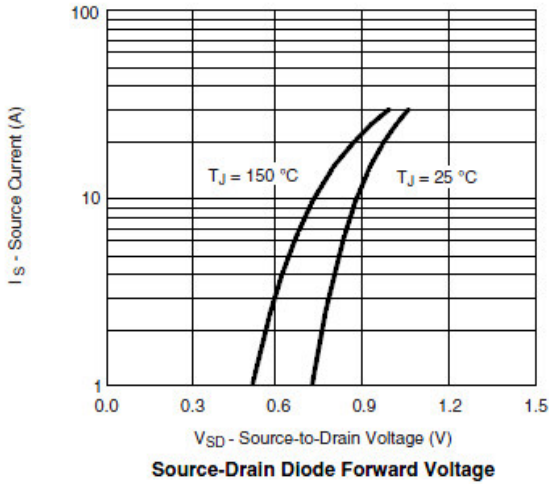
Gate Charge



On-Resistance vs. Junction Temperature



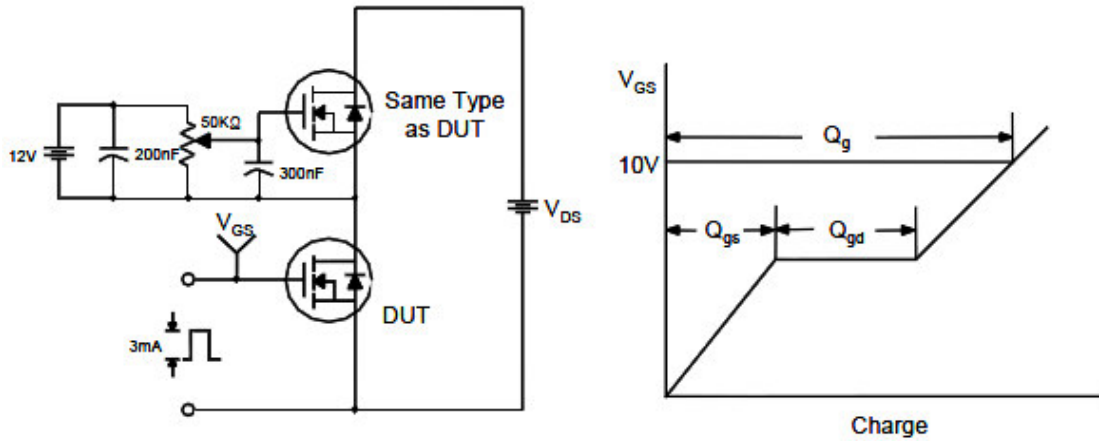
Typical Characteristics (P-Channel)



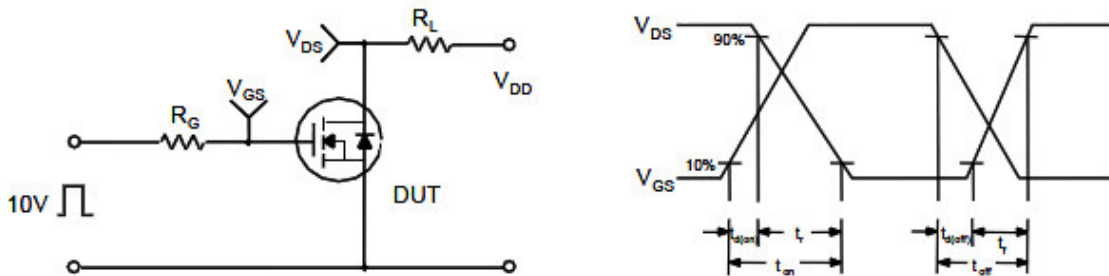


Typical Characteristics

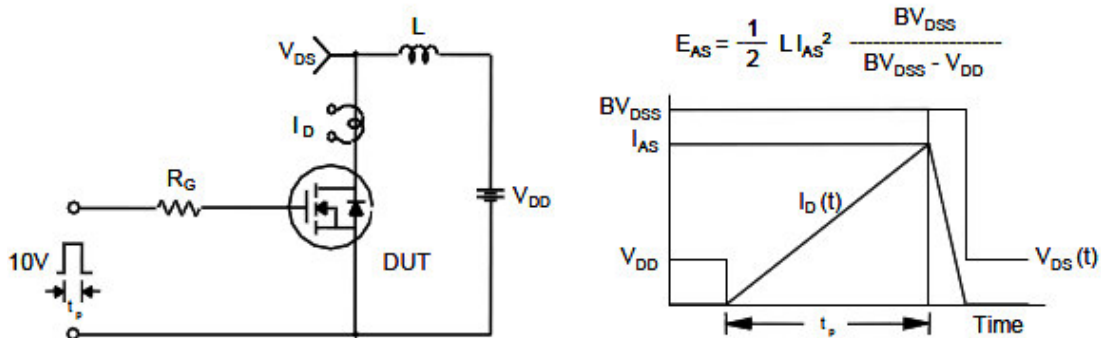
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

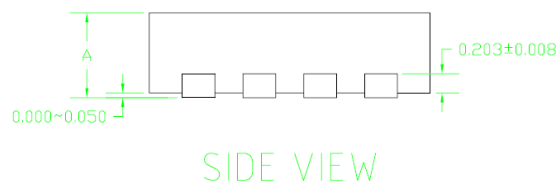
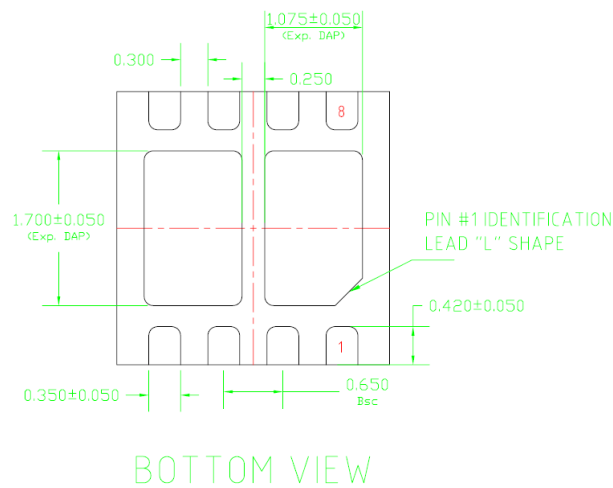
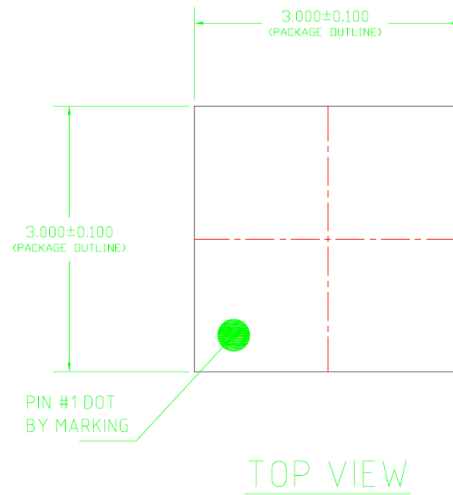


Unclamped Inductive Switching Test Circuit & Waveforms





Package Information (DFN3X3-8L)



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